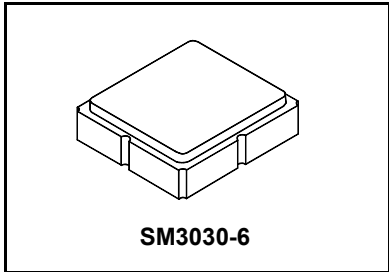


SF1224E-3

**2332.5 MHz
SAW Filter**



- RF SAW Filter, 2332.5 MHz, 25 MHz Bandwidth
- 3.0 x 3.0 x 1.4 mm Surface-mount Case
- Input/Output Impedance 50Ω/50Ω
- Complies with Directive 2002/95/EC (RoHS)
- AEC-Q200



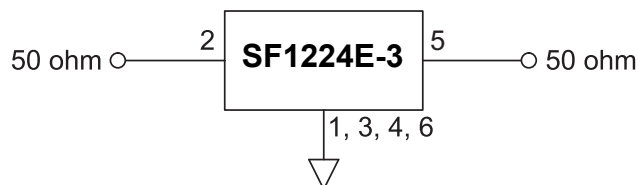
Absolute Maximum Ratings

Rating	Value	Units
Incident Power in Passband	+10	dBm
Incident Power Out of Band	+27	dBm
DC Voltage on any Non-ground Terminal	3	VDC
Temperature Range for Specification	T = -40 to +85	°C
Operating Temperature Range	-40 to +105	°C
Component Storage Temperature Range	-40 to +125	°C
Maximum Soldering Profile, 5 cycles/10 seconds maximum	265	°C

Electrical Characteristics

Characteristic	Sym	Notes	Min	Typ	Max	Units
Center Frequency	f_c			2332.5		MHz
Maximum Insertion Loss, 2320.0 to 2345.0 MHz	IL			0.6	0.9	dB
Passband Ripple 2320.0 to 2345.0 MHz				0.2	0.5	
S11 & S22 VSWR 2320.0 to 2345.0 MHz				1.6	2.0	
Attenuation (Reference level from 0 dB)						dB
824 to 894 MHz			15	20		
1710 to 1755 MHz			16	18		
1850 to 1990 MHz			15	18		
2400 to 2415 MHz			15	17		
2415 to 2600 MHz			15	21		
Terminating Source impedance	Z_s			50		Ω
Terminating Load impedance	Z_L			50		Ω
Temp Coefficient				-36		ppm/k

Single Ended Input / Output, Impedance match	No matching network required for operation at 50 ohms
Case Style	SM3030-6
Lid Symbolization (Y = Year WW = Week S= Shift)	A89



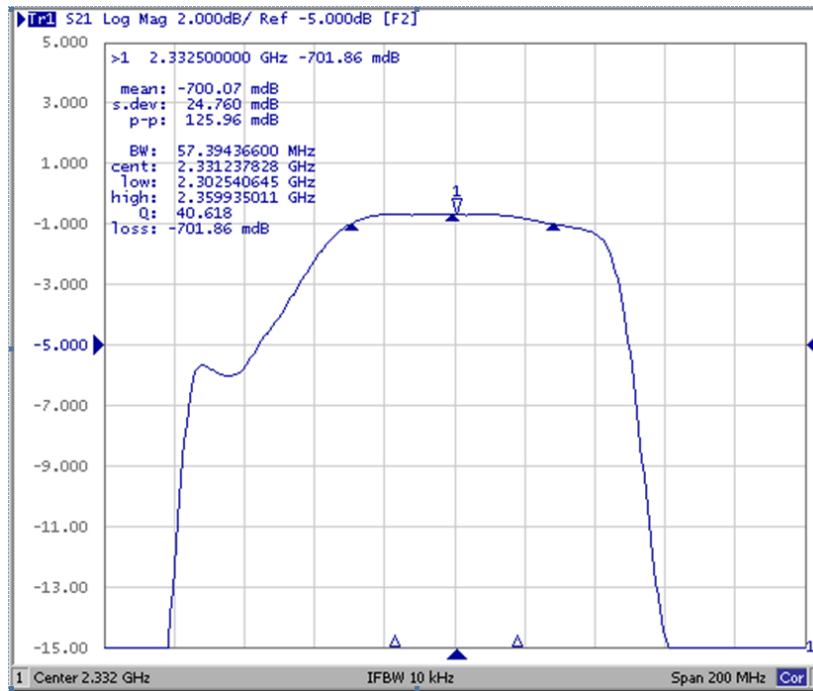
CAUTION: Electrostatic Sensitive Device. Observe precautions for handling.

NOTES:

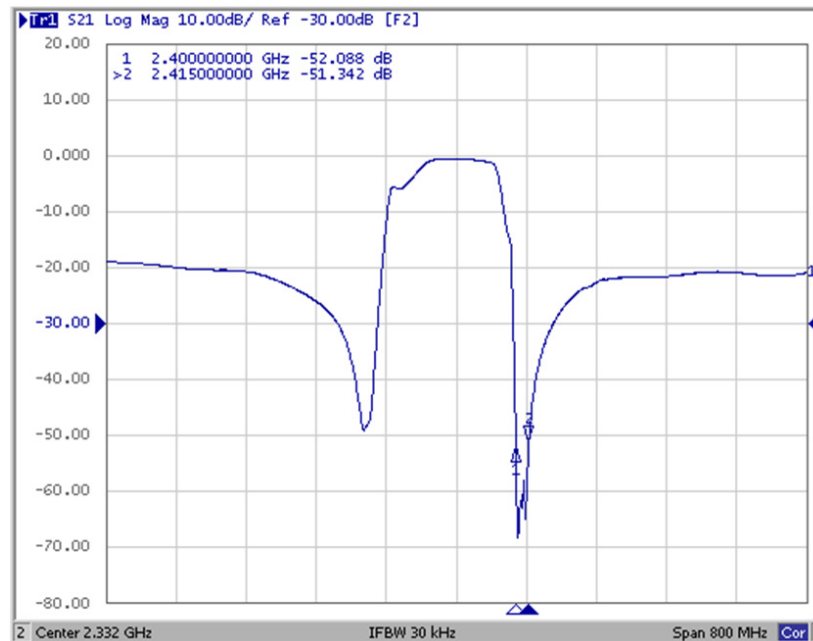
1. US and international patents may apply.
2. Murata, stylized Murata logo, and Murata N.A., Inc. are registered trademarks of Murata Manufacturing Co., Ltd.

Frequency Characteristics

Span - 200 MHz

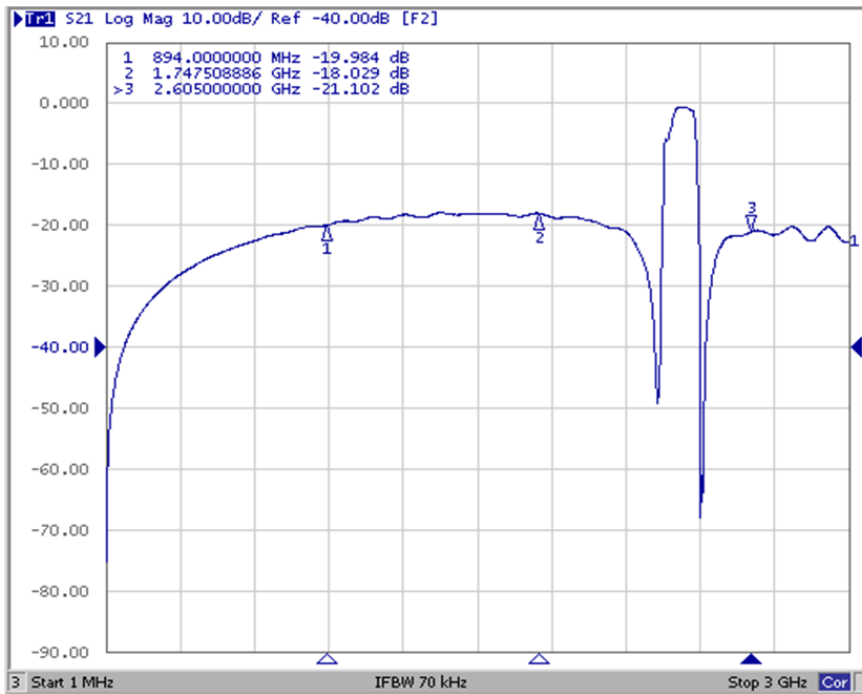


Span - 800 MHz

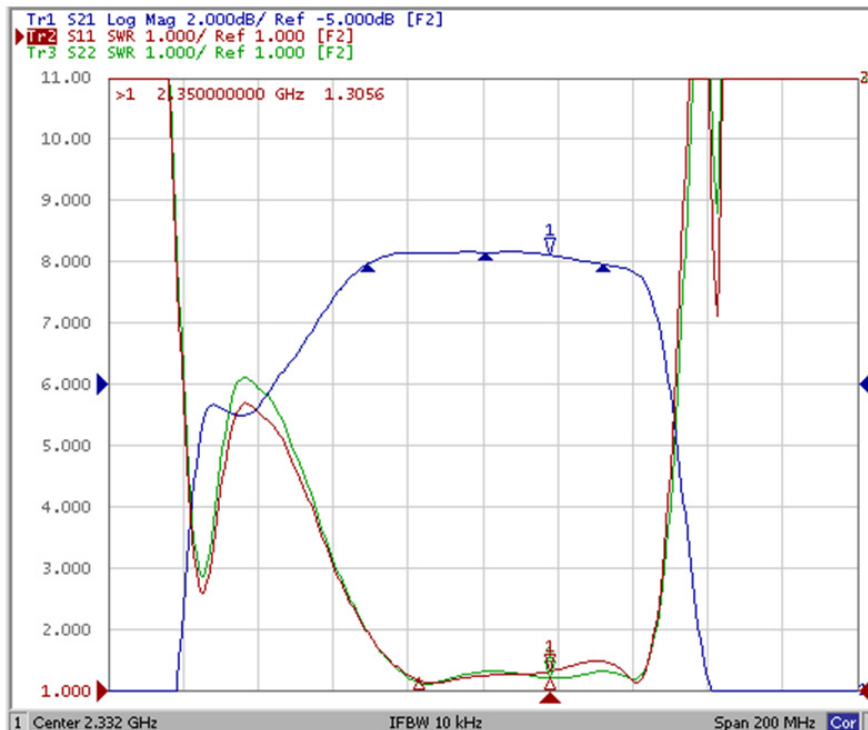


Frequency Characteristics

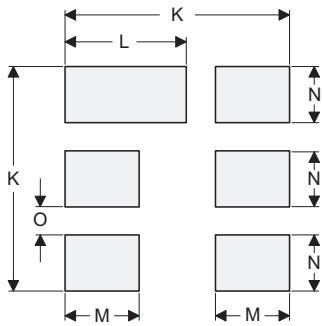
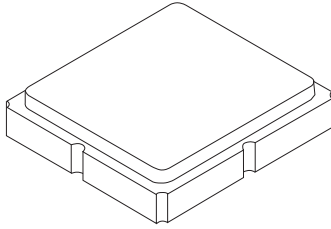
Span - 3000 MHz



Reflection Response - VSWR Span - 200 MHz



6-Terminal Ceramic Surface-Mount Case 3.0 X 3.0 mm Nominal Footprint



PCB Footprint Top View

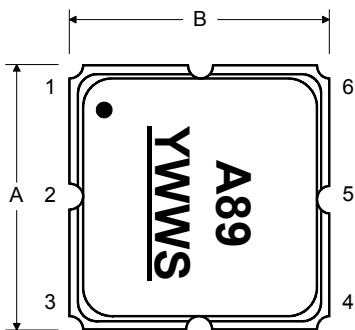
Case and PCB Footprint Dimensions

Dimension	mm			Inches		
	Min	Nom	Max	Min	Nom	Max
A	2.87	3.00	3.13	0.113	0.118	0.123
B	2.87	3.00	3.13	0.113	0.118	0.123
C	1.12	1.25	1.40	0.044	0.049	0.055
D	0.77	0.90	1.00	0.030	0.035	0.039
E	2.67	2.80	2.93	0.105	0.110	0.115
F	1.47	1.60	1.73	0.058	0.063	0.068
G	0.72	0.85	0.98	0.028	0.033	0.038
H	1.37	1.50	1.63	0.054	0.059	0.064
I	0.47	0.60	0.73	0.019	0.024	0.029
J	1.17	1.30	1.43	0.046	0.051	0.056
K		3.20			0.126	
L		1.70			0.067	
M		0.96			0.037	
N		0.81			0.032	
O		0.38			0.015	

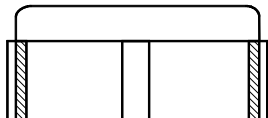
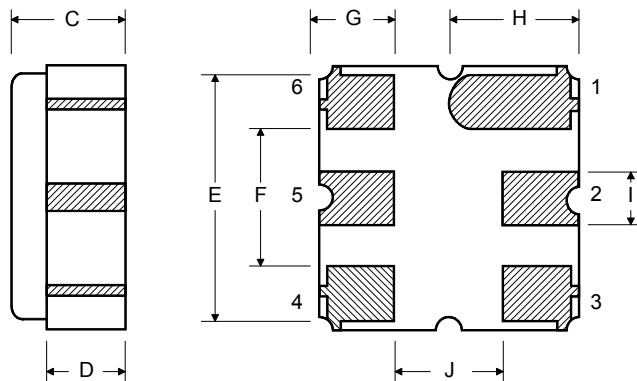
Case Materials

Materials	
Solder Pad Plating	0.3 to 1.0 μm Gold over 1.27 to 8.89 μm Nickel
Lid Plating	2.0 to 3.0 μm Nickel
Body	Al_2O_3 Ceramic
Pb Free	

TOP VIEW



BOTTOM VIEW



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